

IPC/JEDEC J-STD-020E

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JOINT INDUSTRY STANDARD

Moisture/Reflow
Sensitivity Classification
for Nonhermetic Surface
Mount Devices



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Moisture/Reflow Sensitivity Classification for Nonhermetic Surface Mount Devices

A joint standard developed by the IPC Plastic Chip Carrier Cracking Task Group (B-10a) and the JEDEC JC-14.1 Committee on Reliability Test Methods for Packaged Devices

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Users of this standard are encouraged to participate in the development of future revisions.

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